

IARPA-BAA-15-12

This notice is to revise the answer to Question #15 which was included in the 3rd round of Q&As. The answer to the question is revised as shown in red:

Q15: In response to a previous question, RAVEN Q&A Round 1 stated "A successful tool will provide a finished, compiled layer and device images showing the metal, polysilicon, vias, contacts, STI regions, dielectrics and, ideally, the n- and p-wells." In what format should these images be provided?

A15: The preferred format of the images is GDS II; offerors may propose other formats, including but not limited to .jpg, .png, .gif, etc.